



High Voltage, High Speed OPERATIONAL AMPLIFIER

FEATURES

- WIDE POWER SUPPLY VOLTAGE: ±70V to ±150V
- GAIN-BANDWIDTH PRODUCT: 50MHz
- SLEW RATE: 150V/μs
- FET INPUT: I_R = 20pA max
- THERMAL SHUT-DOWN PROTECTION
- HERMETIC TO-3 PACKAGE, ISOLATED CASE

DESCRIPTION

The 3584 is a high voltage, high speed hybrid operational amplifier designed for a wide variety of programmable power supply and transducer driver applications.

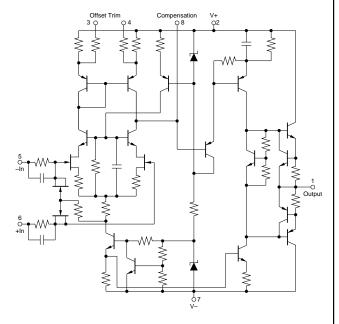
The 3584 operates over a wide power supply range $(\pm 70 \text{V to } \pm 150 \text{V})$ and provides outputs up to 15mA. Laser-trimmed FET input circuitry provides low offset voltage (3mV max) and low input bias current (20pA max). Thermal shut-down circuitry protects internal circuitry from excessive power dissipation.

The 3584 provides a gain-bandwidth product of 20MHz min (50MHz typical). External frequency compensation (series R/C) allows the user to optimize the bandwidth and slew rate for a particular application.

Specified temperature range is 0° C to $+70^{\circ}$ C. The 3584's hermetic 8-pin TO-3 package is electrically isolated from all internal circuitry.

APPLICATIONS

- PROGRAMABLE POWER SUPPLY
- PIEZO-ELECTRIC TRANSDUCER DRIVER
- ELECTROSTATIC TRANSDUCER DRIVER
- CRT DEFLECTION



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SPECIFICATIONS

ELECTRICAL

 T_{CASE} = +25°C, V_{S} = ±150V, unless otherwise noted.

PARAMETER	CONDITIONS	MIN TYP		MAX	UNITS
OFFSET VOLTAGE Input Offset Voltage vs Temperature vs Power Supply vs Time	Specified Temperature Range		20 50	±3 ±25	mV μV/°C μV/V μV/month
INPUT BIAS CURRENT ⁽¹⁾ Input Bias Current vs Temperature vs Power Supply Input Offset Current vs Temperature vs Power Supply	V _{CM} = 0V V _{CM} = 0V		Doubles Every 10°C 0.2 Doubles Every 10°C 0.2	-20 ±20	pA pA/V pA pA/V
NOISE Voltage, 0.01Hz to 10Hz 10Hz to 1kHz Current, 0.01Hz to 10Hz			5 1.7 0.3		μVp-p μVrms pAp-p
INPUT VOLTAGE RANGE Maximum Safe Differential Input Maximum Safe Common-Mode Input Common-Mode Input Range Common-Mode Rejection	Linear Operation		(V+) + V- V- to V+ V _S - 10 110		V dB
INPUT IMPEDANCE Differential Common-Mode			10 ¹¹ 10 10 ¹¹		$\Omega \parallel {\sf pF}$ $\Omega \parallel {\sf pF}$
OPEN-LOOP GAIN Open-Loop Voltage Gain Open-Loop Voltage Gain	No Load, DC Rated Load, DC	100	120		dB dB
FREQUENCY RESPONSE Unity-Gain Bandwidth Gain-Bandwidth Product Full-Power Bandwidth Slew Rate Settling Time: 0.1%	Small-Signal f = 1kHz, G = 100 G = 100 G = 100 G = 100	20	7 135 150 12		MHz MHz kHz V/μs μs
OUTPUT Voltage Output Current Output Short Circuit Current Load Capacitance (Maximum)		V _S - 5 ±15	±25 10		V mA mA nF
POWER SUPPLY Operating Voltage Range Quiescent Current	I _O = 0	±70		±150 ±6.5	V mA
TEMPERATURE RANGE Specification Operating Storage		0 -55 -55		+70 +125 +150	ဝိ ဝိ ဂိ

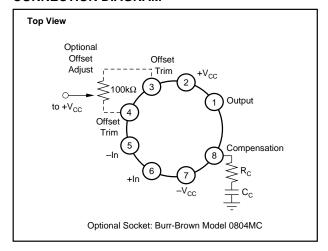
NOTE: (1) Inputs may be damaged by input slew rates exceeding $1000V/\mu s$. Inputs can be protected from signals exceeding $1000V/\mu s$ by limiting input current to 150mA with external series resistors (pins 5 and 6).

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2



CONNECTION DIAGRAM



ORDERING INFORMATION

MODEL	PACKAGE	TEMPERATURE RANGE			
3584JM	8-Pin TO-3	0°C to +70°C			

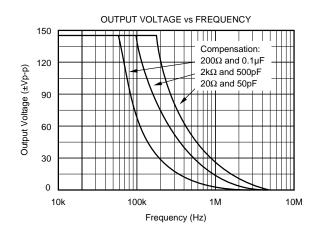
PACKAGE INFORMATION

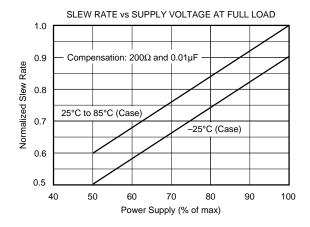
MODEL	PACKAGE	PACKAGE DRAWING NUMBER ⁽¹⁾		
3584JM	8-Pin TO-3	030		

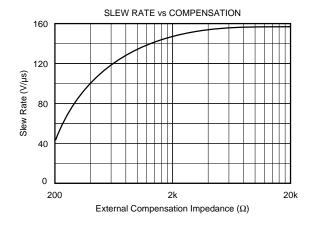
NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix D of Burr-Brown IC Data Book.

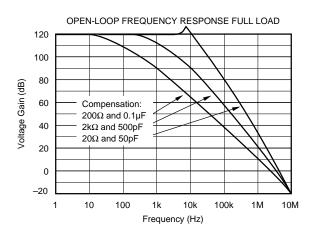
TYPICAL PERFORMANCE CURVES

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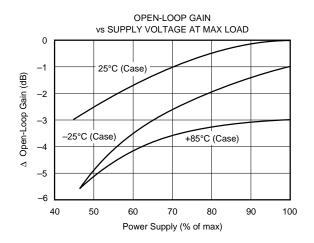


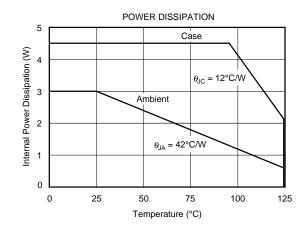
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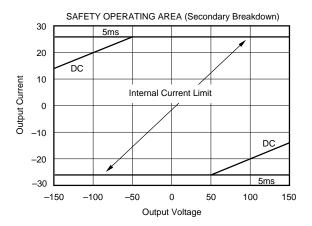
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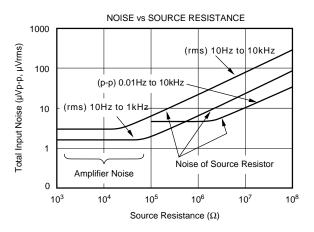
TYPICAL PERFORMANCE CURVES (CONT)

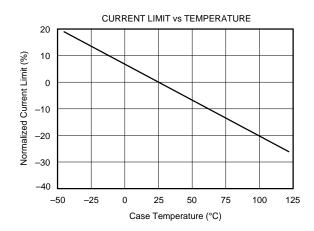
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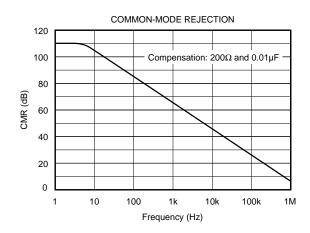








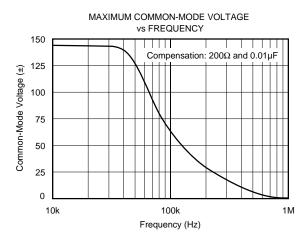


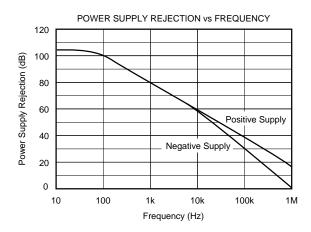




TYPICAL PERFORMANCE CURVES (CONT)

 T_{CASE} = +25°C, V_S = ±150V, unless otherwise noted.





APPLICATION INFORMATION

Figure 1 shows the basic connections required to operate the 3584. Bypass capacitors should be connected close to the device pins. Be sure that these capacitors have an adequate voltage rating.

Frequency compensation components must be connected to pin 8 for closed-loop gains of 100 or less. Recommended values are shown in Figure 1. Some adjustment in these values may be required depending on exact circuit configuration and load conditions. Be sure the compensation capacitor has a voltage rating equal to or greater than the positive power supply voltage, V+. Standard 0.25W resistors can be used for $R_{\rm C}$.

Input offset voltage and drift of the 3584 are laser-trimmed. Many applications require no external offset trimming. Figure 1 shows connection of an optional offset trim potentiometer which connects to pins 3 and 4.

FET input circuitry reduces the input bias current of the 3584 to less than 20pA at room temperature. Input bias current remains nearly constant throughout the full common-mode range. Input bias current approximately doubles for each 10°C increase in case temperature above 25°C. Heat sinking can help minimize this effect by reducing the case temperature.

Input circuitry of the 3584 is protected with series limiting resistors and input clamp diodes. The inputs can withstand the full rated supply voltage of ± 150 V (common-mode or differential).

THERMAL PROTECTION

The 3584 has internal thermal shut-down circuitry that activates at a case temperature of approximately 150°C or higher. As this circuitry is activated, the output current drive is reduced. As the case temperature returns to less than the activation temperature, operation will return to normal.

The thermal shut-down circuit will normally protect the amplifier during a short-circuit to ground. It will not protect against short-circuit to one of the power supplies. The typical performance curve "Safe Operating Area" shows that the large stress occurring during this high voltage condition may cause damage if it exceeds 5ms duration. The thermal protection circuitry will not activate fast enough to protect the device from short-circuits to one of the power supplies.

The package case of the 3584 is electrically isolated from all circuitry. No special insulating hardware is required. Although not absolutely required, it is recommended that the case be connected to ground.

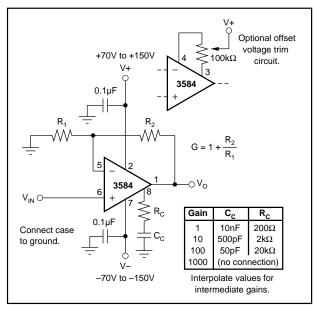


FIGURE 1. Basic Circuit Connections.

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3584



PACKAGE OPTION ADDENDUM

8-Jan-2007

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Pa	ackage Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
3584JM	NRND	TO-3	LMF	8	18	Pb-Free (RoHS Exempt)	Call TI	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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